

July 2016

FSA3030 — High-Speed USB2.0/Mobile High-Definition Link (MHL™) with Negative Swing Audio

Features

- Low On Capacitance: 4.2 pF/5 pF MHL/USB (Typical)
- Low Power Consumption: 30 μA Maximum
- Supports MHL Rev. 2.0
- MHL Data Rate: 4.0 Gbps
- Audio Swing: -1.5 V to +1.5 V (Typical)
- Packaged in 12-Lead UMLP (1.8 x 1.8 mm)
- Over-Voltage Tolerance (OVT) on all USB Ports Up to 5.25 V without External Components

Applications

Cell Phones and Digital Cameras

Description

The FSA3030 is a bi-directional, low-power, high-speed, 3:1, USB2.0, MHL™ and audio switch. Configured as a double-pole, triple-throw (DP3T) switch, it is optimized for switching between high- or full-speed USB, Mobile High-Definition Link sources (per MHL Rev. 2.0 specification) and negative swing capable audio.

The FSA3030 contains special circuitry on the switch I/O pins, for applications where the V_{CC} supply is powered off (V_{CC} =0), that allows the device to withstand an over-voltage condition. This switch is designed to minimize current consumption even when the control voltage applied to the control pins is lower than the supply voltage (V_{CC}). This is especially valuable in mobile applications, such as cell phones, allowing direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, digital cameras, and notebook computers.

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package
FSA3030UMX	LU	-40 to +85°C	12-Lead, Ultrathin Molded Leadless Package (UMLP), 1.8 mm x 1.8 mm

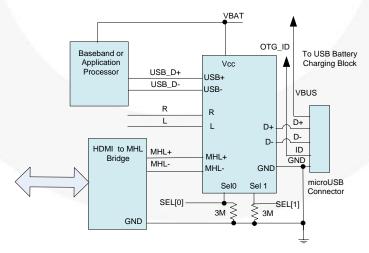


Figure 1. Typical Application

All trademarks are the property of their respective owners.

Analog Symbol

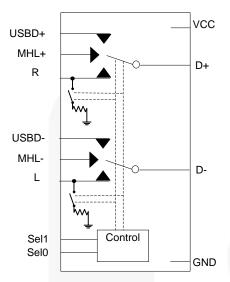


Figure 2. Analog Symbol

Table 1. Data Switch Select Truth Table

SEL1 ⁽¹⁾	SEL0 ⁽¹⁾	Shunt	Function
0	0	Enable	D+/D- connected to USB+/USB-
0	1	Disable	D+/D- connected to R/L
1	0	Enable	D+/D- connected to MHL+/MHL
1	1	Enable	D+/D- High Impedance

Note:

1. Control inputs should never be left floating or unconnected. To guarantee default switch closure to the USB position, the SEL[0:1] pins should be tied to GND with a weak pull-down resistor (3 $M\Omega$) to minimize static current draw.

Pin Configuration

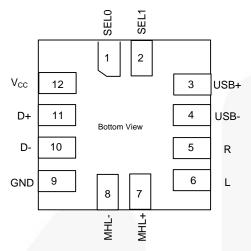


Figure 3. Pin Assignments

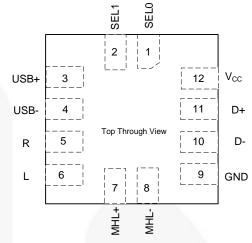


Figure 4. Top Through View

Pin Definitions

Pin#	Name	Description	
1	SEL0	Data Switch Select	
2	SEL1	Data Switch Select	
3	USB+	USB Differential Data (Positive)	
4	USB-	USB Differential Data (Negative)	
5	R	Audio Right	
6	L	Audio Left	
7	MHL+	MHL Differential Data (Positive)	
8	MHL-	MHL Differential Data (Negative)	
9	GND	Ground	
10	D-	Data Switch Output (Positive)	
11	D+	Data Switch Output (Negative)	
12	V _{CC}	Device Power from System	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Parameter			Unit
Vcc	Supply Voltage	KI .	-0.5	6.0	V
V _{CNTRL}	DC Input Voltage (SEL[1:0]) ⁽²⁾		-0.5	V _{CC}	V
		USB	-0.5	Vcc	
$V_{SW}^{(3)}$	DC Switch I/O Voltage ⁽²⁾	MHL	-0.5	V _{CC}	V
		AUDIO	-2.0	3	
I _{IK}	DC Input Diode Current		-50		mA
		USB	1	60	mA
l _{out}	Switch DC Output Current (Continuous)	MHL		60	mA
		AUDIO		60	mA
1	Switch DC Output Peak Current (Pulsed at 1 ms Duration, <10% Duty Cycle)	USB	1	150	mA
I _{OUTPEAK}		MHL		150	mA
1/2	(1 dioca at 1 mo Baration, \$1070 Buty Gyolo)	AUDIO		150	mA
T _{STG}	Storage Temperature		-65	+150	°C
MSL	Moisture Sensitivity Level: JEDEC J-STD-020A			1	
	IEC 61000-4-2, Level 4, for D+/D- and V _{CC} Pins ⁽⁴⁾	Contact		8	
ESD	IEC 61000-4-2, Level 4, for D+/D- and V _{CC} Pins ⁽⁴⁾	Air		15	kV
ESD	Human Body Model, JEDEC: JESD22-A114	All Pins		3.5	l v
	Charged Device Model, JESD22-C101			2	

Notes:

- 2. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.
- 3. V_{SW} refers to analog data switch paths (USB, MHL, and audio).
- 4. Testing performed in a system environment using TVS diodes.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	2.5	4.5	V
t _{RAMP(VCC)}	Power Supply Slew Rate	100	1000	μs/V
Θ_{JA}	Thermal Resistance		230	°C/W
V _{CNTRL}	Control Input Voltage (SEL[1:0]) ⁽⁵⁾	0	4.5	V
V _{SW(USB)}	Switch I/O Voltage (USB Switch Path)	-0.5	3.6	V
V _{SW(MHL)}	Switch I/O Voltage (MHL Switch Path)	1.65	3.45	V
V _{SW(AUD)}	Switch I/O Voltage (Audio Switch Path)	-1.5	3.0	V
T _A	Operating Temperature	-40	+85	°C

Note:

5. The control inputs must be held HIGH or LOW; they must not float.

DC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Cumahal	Doromotor	Condition	V AA	T _A =- 40°C to +85°C			Unit
Symbol	Parameter	Condition	V _{CC} (V)	Min.	Тур.	Max.	Unit
V _{IK}	Clamp Diode Voltage	I _{IN} =-18 mA	2.5			-1.2	V
V _{IH}	Control Input Voltage High SEL[1:0]		2.5 to 4.50	1.0			V
V _{IL}	Control Input Voltage Low SEL[1:0]		2.5 to 4.50			0.5	V
I _{IN}	Control Input Leakage SEL[1:0]	V _{SW} (USB/MHL)=0 to 3.6 V, V _{SW} (AUD)=0 to 3.0 V, V _{CNTRL} =0 to V _{CC}	4.5	-0.5		0.5	μΑ
I _{OZ(MHL)}	Off-State Leakage for Open MHL Data Paths	$\begin{aligned} &V_{\text{SW}}\text{=}1.65 \leq \text{MHL} \leq 3.45 \text{ V} \\ &\text{SEL[1:0]}\text{=}V_{\text{CC}} \end{aligned}$	4.5	-1		1	μΑ
I _{OZ(USB)}	Off-State Leakage for Open USB Data Paths	V_{SW} =0 \leq USB \leq 3.6 V SEL[1:0]= V_{CC}	4.5	-0.5		0.5	μA
I _{CL(MHL)}	On-State Leakage for Closed MHL Data Paths ⁽⁶⁾	$\begin{tabular}{lll} V_{SW}=$1.65 & & MHL \\ & \le 3.45 \ V, \ SEL0$=$GND, \\ SEL1$=$V_{CC}, \ Other \ Side \ of \\ Switch \ Float \\ \end{tabular}$	4.5	-0.75		0.75	μΑ
I _{CL(USB)}	On-State Leakage for Closed USB Data Paths ⁽⁶⁾	$V_{SW}=0 \le USB \le 3.6 \text{ V}$ SEL[1:0]=GND, Other Side of Switch Float	4.5	-0.75		0.75	μΑ
I _{CL(AUD)}	On-State Leakage for Closed ⁽⁶⁾ AUDIO Data Path	V_{SW} =-1.5 \leq R/L \leq 1.5 V SEL1=GND, SEL0= V_{CC} , Other Side of Switch Float	4.5	-1.0		1.0	μΑ
I _{OFF}	Power-Off Leakage Current (All I/O Ports)	VSW(USB/MHL)=0 to 3.6 V, VSW(AUD)=0 to 3.0 V, Figure 5	0	-1		1	μΑ
R _{ON(USB)}	HS Switch On Resistance (USB to D Path)	V _{SW} =0.4 V, I _{ON} =-8 mA, SEL[1:0]=GND, Figure 6	2.5		4.5		Ω
R _{ON(MHL)}	HS Switch On Resistance (MHL to D Path)	V _{SW} =V _{CC} -1050 mV, SEL0=GND, SEL1=V _{CC} I _{ON} =-8 mA, Figure 6	2.5	7	5		Ω
R _{ON(Audio)}	Audio Switch On Resistance (R/L Path)	V _{SW} = -1.5 V to 1.5 V, SEL1=GND, SEL0=V _{CC} , I _{ON} =-24 mA, Figure 6	2.5		4		Ω
$\Delta R_{ ext{ON(MHL)}}$	Difference in R _{ON} Between MHL Positive-Negative	V _{SW} =V _{CC} -1050 mV, SEL0=GND, SEL1=V _{CC} , I _{ON} =-8 mA, Figure 6,	2.5		0.03		Ω
$\Delta R_{ON(USB)}$	Difference in R _{ON} Between USB Positive-Negative	V _{SW} =0.4 V, I _{ON} = -8 mA, SEL[1:0]=GND, Figure 6	2.5		0.18		Ω
R _{ONF(MHL)}	Flatness for R _{ON} MHL Path	V _{SW} =1.65 to 3.45V, SEL0=GND, SEL1=V _{CC} , I _{ON} =-8 mA, Figure 6	2.5		1		Ω
R _{ONFA(AUDIO)}	Flatness for R _{ON} Audio Path	V _{SW} =-1.5 V to 1.5 V, SEL1=GND, SEL0=V _{CC} , I _{ON} =-24 mA, Figure 6	2.5		0.1		Ω
R _{SH}	Shunt Resistance		3.6		125	200	Ω
I _{CC}	Quiescent Current	V _{CNTRL} =0 or 4.5 V, I _{OUT} =0	4.5			30	μΑ
I _{CCT}	Delta Increase in Quiescent	V _{CNTRL} =1.65 V, I _{OUT} =0	4.5			18	μΑ
1001	Current per Control Pin	V _{CNTRL} =2.5 V, I _{OUT} =0	4.5			10	μ, (

Note:

6. For this test, the data switch is closed with the respective switch pin floating.

AC Electrical Characteristics

All typical values are for V_{CC} =3.3 V and T_{A} =25°C unless otherwise specified.

Cumbal	Deversator	Condition	v 00	T _A =- 40°C to +85°C			Unit
Symbol	Parameter	Condition	V _{CC} (V)	Min.	Тур.	Max.	Unit
t _{ONUSB}	USB Turn-On Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5 pF, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3.3 V, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
t _{OFFUSB}	USB Turn-Off Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5 pF, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3.3 V, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
t _{ONAUD}	AUDIO Turn-On Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5 pF, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3.3 V, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
toffaud	AUDIO Turn-Off Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5p F, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3.3 V, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
tonmhl	MHL Turn-On Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5 pF, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
t _{OFFMHL}	MHL Turn-Off Time, SEL[1:0] to Output	R _L =50 Ω , C _L =5 pF, V _{SW(USB)} =0.8 V, V _{SW(MHL)} =3.3 V, V _{SW(AUD)} =1.5 V, Figure 7, Figure 8	2.5 to 3.6		445	600	ns
t _{PD}	Propagation Delay ⁽⁷⁾	C_L =5 pF, R_L =50 Ω , Figure 7, Figure 9	2.5 to 3.6		0.25		ns
t _{BBM}	Break-Before-Make ⁽⁷⁾	R_L =50 Ω , C_L =5 pF, V_{AUD} =1.5 V, V_{MHL} =3.3 V, V_{USB} =0.8 V, Figure 10	2.5 to 3.6		350		ns
O _{IRR(MHL)}	Off Isolation ⁽⁷⁾	V_S =1 V_{pk-pk} , R_L =50 Ω , f=240 MHz, Figure 11	2.5 to 3.6		-33		dB
O _{IRR(USB)}	On isolation.	V_S =400 m V_{pk-pk} , R _L =50 Ω , f=240 MHz, Figure 11	2.5 to 3.6		-38		dB
Xtalk _{MHL}		V_S =1 V_{pk-pk} , R_L =50 Ω , f=240 MHz, Figure 12	2.5 to 3.6	A	-44		dB
Xtalk _{USB}	Non-Adjacent Channel ⁽⁷⁾ Crosstalk	V_S =400 m V_{pk-pk} , R $_L$ =50 Ω , f=240 MHz, Figure 12	2.5 to 3.6	/	-39	Ţ,	dB
Xtalk _{AUD}		V_S =100 m V_{RMS} , R_L =32 Ω , f=20 kHz, Figure 12	2.5 to 3.6		-70		dB
THD	Total Harmonic Distortion ⁽⁷⁾	R_T =32 Ω , V_{SW} =2 V_{pk-pk} , f=20 Hz to 20 kHz, V_{BIAS} =0 V	2.5		0.01		%
	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	V_{IN} =1 $V_{\text{pk-pk}}$, Common Mode Voltage = V_{CC} - 1.1 V, MHL Path, R_{L} =50 Ω , C_{L} =0 pF, Figure 13			2.0	6	GHz
BW	S _{DD21} Differential -3 db Bandwidth ⁽⁷⁾	V_{IN} =400 m $V_{\text{pk-pk}}$, Common Mode Voltage=0.2 V, USB Path, R _L =50 Ω , C _L =0 pF, Figure 13	2.5 to 3.6		1.80	Ų	GHZ
		AUDIO Path, $R_L=50 \Omega$, $C_L=0 pF$			50		MHz

Note:

7. Guaranteed by characterization.

USB High-Speed AC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	Тур.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁸⁾	$C_L=5$ pF, $R_L=50$ Ω , Figure 14	3.0 to 3.6	3	ps
t∪	Total Jitter ⁽⁸⁾	R_L =50 Ω, C_L =5 pf, t_R = t_F =500 ps (10-90%) at 480 Mbps, PN7	3.0 to 3.6	15	ps

Note:

8. Guaranteed by characterization.

MHL AC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	Тур.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁹⁾	R _{PU} =50 Ω to V _{CC} , C _L =0 pF	3.0 to 3.6	3	ps
tJ	Total Jitter ⁽⁹⁾	f=2.25 Gbps, PN7, R _{PU} =50 Ω to V _{CC} , C _L =0 pF	3.0 to 3.6	26	ps

Note:

9. Guaranteed by characterization.

Capacitance

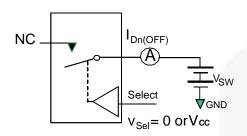
All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	Тур.	Unit
C _{IN}	Control Pin Input Capacitance ⁽¹⁰⁾	V _{CC} =0 V, f=1 MHz	1.5	
C _{ON(USB)}	USB Path On Capacitance ⁽¹⁰⁾	V _{CC} =3.3 V, f=240 MHz, Figure 15	6.5	/
C _{OFF(USB)}	USB Path Off Capacitance (10)	V _{CC} =3.3 V, f=240 MHz, Figure 16	2.5	
C _{ON(MHL)}	MHL Path On Capacitance ⁽¹⁰⁾	V _{CC} =3.3 V, f=240 MHz, Figure 15	6.5	pF
C _{OFF(MHL)}	MHL Path Off Capacitance ⁽¹⁰⁾	V _{CC} =3.3 V, f=240 MHz, Figure 16	2.5	
C _{ON(AUD)}	Audio Path On Capacitance ⁽¹⁰⁾	V _{CC} =3.3 V, f=1 MHz, Figure 15	8.0	
C _{OFF(AUD)}	Audio Path Off Capacitance ⁽¹⁰⁾	V _{CC} =3.3 V, f=1 MHz, Figure 16	2.5	

Note:

10. Guaranteed by characterization.

Test Diagrams



**Each switch port is tested separately

Figure 5. Off Leakage

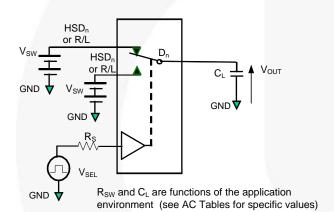


Figure 7. AC Test Circuit Load

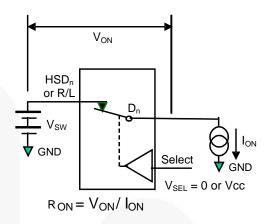


Figure 6. On Resistance

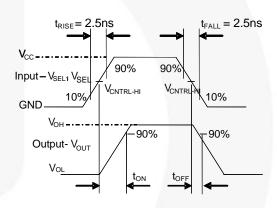


Figure 8. Turn-On / Turn-Off Waveforms

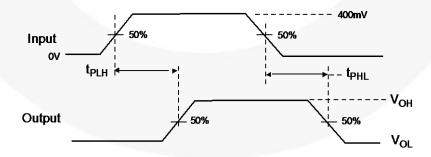


Figure 9. Propagation Delay (t_Rt_F - 500ps)

Note:

11. HSD_n refers to the high-speed data USB or MHL paths.

Test Diagrams

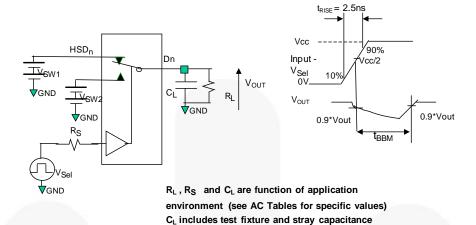
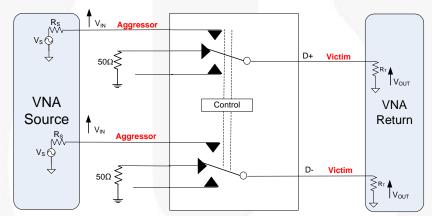
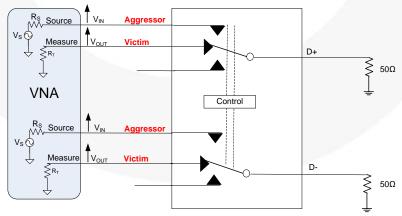


Figure 10. Break-Before-Make Interval Timing



 V_S , R_S and R_T are functions of the application environment (see AC/DC Tables for values). Off Isolation = 20 Log (V_{OUT} - V_{IN})

Figure 11. Channel Off Isolation (SDD21)

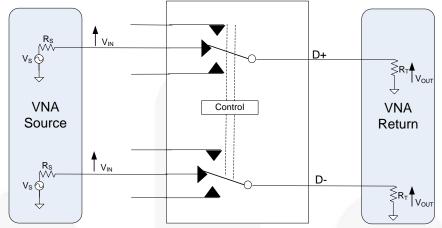


VS, RS and RT are functions of the application environment (see AC/DC Tables for values).

Off Isolation = 20 Log (VOUT - VIN)

Figure 12. Non-Adjacent Channel-to-Channel Crosstalk (SDD21)

Test Diagrams



V_S, R_S and R_T are functions of the application environment (see AC/DC Tables for values).

Figure 13. Insertion Loss (SDD21)

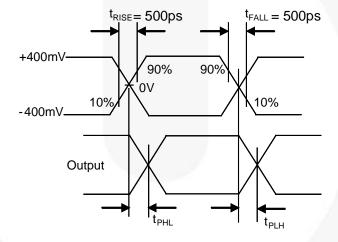


Figure 14. Intra-Pair Skew Test t_{SK(P)}

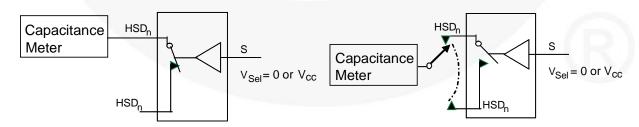


Figure 15. Channel On Capacitance

Figure 16. Channel Off Capacitance

Functional Description

Insertion Loss

One of the key factors for using the FSA3030 in mobile digital video applications is the small amount of insertion loss experienced by the received signal as it passes through the switch. This results in minimal degradation of the received eye. One of the ways to measure the quality of the high data rate channels is using balanced ports and four-port differential S-parameter analysis, particularly SDD21.

Bandwidth is measured using the S-parameter SDD21 methodology.

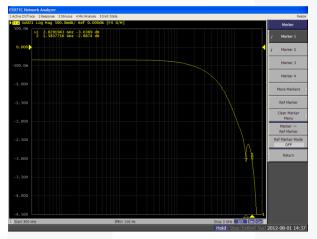


Figure 17. MHL Path SDD21 Insertion Loss Curve

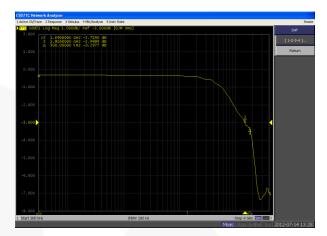


Figure 18. USB Path SDD21 Insertion Loss Curve

Typical Applications

Figure 19 shows the FSA3030 utilizing the V_{BAT} connection. The 3M resistors are used to ensure, for manufacturing test via the micro-USB connector, that the FSA3030 configures for connectivity to the baseband or application processor.

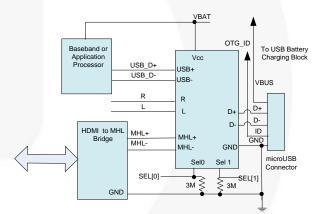
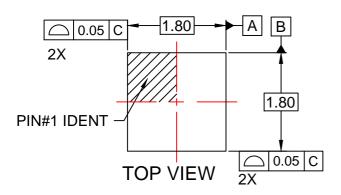
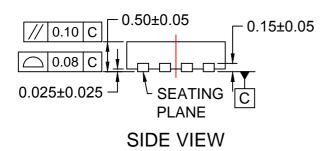


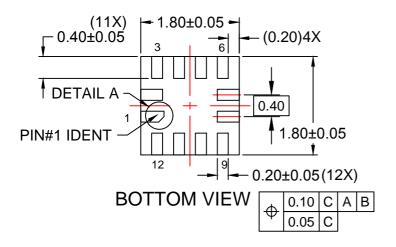
Figure 19. MHL Path SDD21 Insertion Loss Curve

Table 2. Product-Specific Package Dimensions

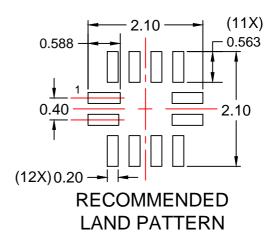
Nominal Values (mm)
0.50
0.012
0.15
0.20
0.40
0.40
Min: 1.70, Nom: 1.80, Max: 1.90
Min: 1.70, Nom: 1.80, Max: 1.90
0.40
0.20
0.10
0.10
0.10

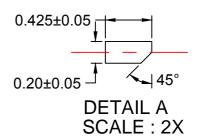












NOTES:

- A. PACKAGE DOES NOT CONFORM TO ANY JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-UMLP12Arev5.







TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 $\begin{array}{lll} \mathsf{AccuPower^{\mathsf{TM}}} & \mathsf{F-PFS^{\mathsf{TM}}} \\ \mathsf{AttitudeEngine^{\mathsf{TM}}} & \mathsf{FRFET}^{\texttt{®}} \end{array}$

Awinda[®] Global Power Resource SM

AX-CAP®* GreenBridge™
BitSiC™ Green FPS™
Build it Now™ Green FPS™ e-Series™

Current Transfer Logic™ Making Small Speakers Sound Louder

DEUXPEED® and Better™

Dual Cool™ MegaBuck™

EcoSPARK® MICROCOUPLER™

EfficientMax™ MicroFET™

EfficientMax™ MicroFET™
ESBC™ MicroPak™
MicroPak™
MicroPak2™
Fairchild® MillerDrive™
MotionMax™
Fairchild Semiconductor®

Farchild Semiconductor

FACT Quiet Series™
FACT®

FastvCore™
FETBench™
FPS™

MotionGrid®
MTI®
MTX®
MVN®
FETBench™
MVN®
FPS™

OptoHiT™
OPTOLOGIC®

OPTOPLANAR®

Power Supply WebDesigner™ PowerTrench®

PowerXS™

Programmable Active Droop™ OFFT®

QS™ Quiet Series™ RapidConfigure™

TM TM

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

SYSTEM GENERAL®'
TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyPWM™
TranSiC™
TriFault Detect™
TRUECURRENT®**
uSerDes™

SerDes"
UHC[®]
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
XS™
XS™

仙童®

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT http://www.fairchildsemi.com, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Deminition of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 177

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

FSA3030UMX